FORM PTO-1595

01-12-2000



U.S. Department of Commerce Patent and Trademark Office

NRD 12.27.99

101243152

	o the Assistant Commissioner for Patent.	1012431	102	or copy thereof.
1.	Name of conveying party(ies):	27 1889	2. Name and Addr	ress of receiving party(ies):
	Antonio L.P. Rotondaro	199	Name:	Texas Instruments Incorporated
	Reima Tapani Laaksonen	1809	Address:	PO Box 655474, M/S 3999
	Robert Kraft	ι' 🕌	City: State:	Dallas
	Charlotte M. Appel Rebecca J. Gale		Zip:	Texas 75265
	Katherine E. Violette		-	10200
A	dditional name(s) attached? Yes _X_ No	-	Additional name(s)	& address(es) attached? Yes _X_ No
3.	Nature of Conveyance:			
	X Assignment	Merger		
	Security Agreement	Change of Name		
	Other			
	Execution Date: 12/02/1999, 12/09/1999, 12/03/	/1999, 12/07/1999 &	12/15/1999	
4.	Application number(s) or patent number(s).			
	This document is being filed toge			
	Execution date of the application: 12/02/1999,	12/09/1999, 12/03/19	999, 12/07/1999 & 1	2/15/1999
	Title: Silicon Processing Method Docket: TI-25665			
	Filing Date: 10/15/1999			
A	. Patent Application No.(s)		B. Patent No.(s)	
	09/419,606			
	Additional numbers attached?YesX_	_ No	Additiona	al numbers attached? YesX No
5.	Name and address of party to whom correspond concerning document should be mailed:	dence	6. Number of applic	cations and patents involved:1
	•			
	Name: Carlton H. Hoel			
	Texas Instruments Incorporated Address: PO Box 655474, M/S 3999			
	City: Dallas			
	State: Texas Zip: 75265	<u> </u>		
			7. Amount of fee er	aclosed or authorized to be charged: \$40
Ì		-	8. Deposit accour	nt number (Attach two copies of this form if
			paying by depo	osit account): 20-0668
- 1	DHGUYEN 0000033 200668 09419606		THE COLCE	
000 1		TO A STORE THAT II	THIS SPAUR	
	40.00 CH	DO NOT USE T	ins of nez	
	/	DO NOT USE T		
B1 	/	DO NOT USE T		
B1 9	. Statement and signature.			any attached copy is a true copy of the original
9	(40.00 CH			any attached copy is a true copy of the original
9 7 d	40.00 CH Statement and signature. To the best of my knowledge and belief, the foregoing the statement and signature.	ing information is tr		

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, M/S 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	Silicon Processing Method
SIGNATURE OF INVENTOR AND NAME	Antonio L.P. Rotondaro
DATE	x Dec OZ, 1939
RESIDENCE (CITY AND STATE)	Dallas, Texas
DATE APPLICATION EXECUTED	x Dec 02, 1939

TITLE OF INVENTION	Silicon Processing Method
SIGNATURE OF INVENTOR AND NAME	X Vaponi Xaalisomer Reima Tapani Laaksonen
DATE	x Fopari da Dec -02 - 1999
RESIDENCE (CITY AND STATE)	Dallas, Texas
DATE APPLICATION EXECUTED	x Dec-02-1999

TITLE OF INVENTION	Silicon Processing Method
SIGNATURE OF INVENTOR AND NAME	Robert Kraft
DATE	x 12/9/99
RESIDENCE (CITY AND STATE)	Plano, Texas
DATE APPLICATION EXECUTED	X 12/9/99

TITLE OF INVENTION	Silicon Processing Method
SIGNATURE OF INVENTOR AND NAME	Charlotte M. Appel
DATE	x 12/3/99
RESIDENCE (CITY AND STATE)	Dallas, Texas
DATE APPLICATION EXECUTED	× 12/3/99

TITLE OF INVENTION	Silicon Processing Method
SIGNATURE OF INVENTOR AND NAME	X Sibility Gale Rebecca J. Gale
DATE	× 12/4/99
RESIDENCE (CITY AND STATE)	Allen, Texas
DATE APPLICATION EXECUTED	x 12/7/99